



# I.MX6 SOM-M3

# System on Module

Boasts speeds of up to \*1.2 GHz and contains both on-board Wi-Fi (802.11 a/b/g/n) and Bluetooth 4.1.

Today's smart systems provide increasing amounts of information to make more intelligent decisions for efficiency, security, cost, quality, and productivity. The vast amounts of data these smart systems transfer requires a combination of software-based control with real-time processing capability and optimized system interfaces.

Logic PD's i.MX6 SOM-M3 can help you realize a faster time to market and reduce design risk, providing high-performance multimedia processing for next-generation smart devices. Utilizing NXP's i.MX6 technology, the scalable multicore architecture provides the platform to develop a portfolio of devices on a single hardware design. In addition, the wireless interface provides industry-leading wireless connectivity performance for local and wide area networks

The i.MX6 SOM-M3 is available in several footprint-compatible configurations including single-, dual-, and quad-core ARM® Cortex™ A9 options. With a low stack height and compact footprint, the i.MX6 SOM-M3 is an excellent choice for next-generation medical, military/aerospace, and industrial applications where space is at a premium. Power-efficient processing capabilities, with cutting-edge 3D graphics and high-definition video, ensure superior performance while minimizing power usage.





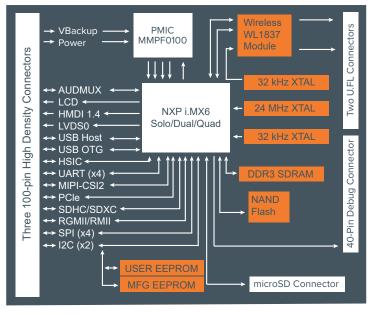
### I.MX6 SOM-M3

Logic PD has the experience and knowledge to help you integrate the i.MX6 SOM-M3 into your product design, select the right NXP i.MX6 platform, and develop a customized i.MX6 SOM-M3 to meet the needs of your application.

## i.MX6 SOM-M3 :: HIGHLIGHTS:

- +Product-ready System on Module with an NXP i.MX6 single-, dual-, or quad-core ARM® Cortex™-A9 processor running up to 1 GHz (single) or 1.2 GHz (dual/quad)
- + Network connectivity: 802.11 a/b/g/n & Bluetooth 4.1 Bluetooth Low Energy (BLE) support Multiple Input/Multiple Output (MIMO) support
- +Commercial temp (0°C to 70°C) Extended temp (-25C to +85C) (Junction temperature must be kept below thresholds)
- +Compact form factor (57 x 35 x 8 mm)
- +Long product lifecycle

# i.MX6 SOM-M3 Block Diagram



57 mm

TOP VIEW :: ACTUAL SIZE

(Block diagram is not drawn to scale; for reference purposes only.)

# i.MX6 SOM-M3 Ordering Information

Model Number	Processor Cores	Speed (MHz)	DDR3 (GB)	NAND Flash (GB)	802.11 Ethernet	Bluetooth	Temp. (°C)
SOMIMX6D-10-1A90ALXR	Dual	1000	2	1	a/b/g/n	BLE/4.1	-25° – 85°
SOMIMX6Q-10-1A90ALXR	Quad	1000	2	1	a/b/g/n	BLE/4.1	-25° – 85°

NOTE: Custom configurations are available by special order. Please contact Logic PD Sales for details



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+Logic PD Technical Support : support.logicpd.com

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# **Product Features**

#### Processor

+NXP i.MX6 single-, dual-, or quad-core ARM® Cortex™-A9 processor running up to 1 GHz (single) or 1.2 GHz (dual/ quad)

## **Embedded Memory**

- +32-bit wide DDR3L-1066, 2 GB (dual/quad)
- +NAND flash, 1 GB

# **Network Connectivity**

- +802.11a/b/g/n
- +Bluetooth 4.1
- +BLE support
- +MIMO support

# Display

- +3- and 4-bit LVDS display port support
- +Hardware supports 18- and 24-bit color

#### Camera

+MIPI CSI-2 interface (Up to 4 lanes with dual/quad configuration)

#### Audio

- +Enhanced Serial Audio Interface (ESAI)
- +Digital audio multiplexer with 4- and 6-wire interface support

#### Removable Storage

- +MicroSD card support
- +SDXC & SDHC interface support

## USB

- +One USB 2.0 high-speed host interface
- +One USB 2.0 high-speed On-the-Go interface

#### Serial I/O

+Up to (4) UART, (2) I2C, & (4) SPI interfaces

#### **GPIO**

- +130+ multiplexed GPIOs supporting various peripherals such as PWMs, SDIO, UART, SPI, I2C, CAN, HSIC, RGMII, and RMII
- +16-bit, multiplexed parallel host bus
- +I/O banks are selectable as 1.8V and 3.3V

#### Debug

+JTAG & ETM support

# Mechanical

- +SOM-M3 form factor
- +57 mm wide x 35 mm long x 8 mm high

# **RoHS Compliant**